## VSMY2890RGX01, VSMY2890GX01

**Vishay Semiconductors** 

## High Speed Infrared Emitting Diodes, 890 nm, Surface Emitter Technology

VSMY2890RGX01

www.vishay.com

VSMY2890GX01



### DESCRIPTION

As part of the <u>SurfLight</u><sup>™</sup> portfolio, the VSMY2890 series are infrared, 890 nm emitting diodes based on GaAlAs surface emitter chip technology with extreme high radiant intensities, high optical power and high speed, molded in clear, untinted plastic packages (with lens) for surface mounting (SMD).

### **APPLICATIONS**

- Automotive sensors
- Photointerrupters
- Emitter source for proximity sensors
- IR illumination

### **FEATURES**

- Package type: surface-mount
- · Package form: GW, RGW
- Dimensions (L x W x H in mm): 2.3 x 2.3 x 2.8
- AEC-Q101 gualified
- Peak wavelength:  $\lambda_p = 890 \text{ nm}$
- Angle of half intensity:  $\varphi = \pm 10^{\circ}$
- Suitable for high pulse current operation
- · Terminal configurations: gullwing or reverse gullwing
- Package matches with detector VEMD2500X01 series
- Floor life: 4 weeks, MSL 2a, according to J-STD-020
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

| PRODUCT SUMMARY |                                 |       |                     |                     |  |
|-----------------|---------------------------------|-------|---------------------|---------------------|--|
| COMPONENT       | $I_e$ (mW/sr) at $I_F$ = 100 mA | φ (°) | λ <sub>P</sub> (nm) | t <sub>r</sub> (ns) |  |
| VSMY2890RGX01   | 135                             | ± 10  | 890                 | 15                  |  |
| VSMY2890GX01    | 135                             | ± 10  | 890                 | 15                  |  |

#### Note

Test conditions see table "Basic Characteristics"

| ORDERING INFORMATION |               |                              |                  |  |
|----------------------|---------------|------------------------------|------------------|--|
| ORDERING CODE        | PACKAGING     | REMARKS                      | PACKAGE FORM     |  |
| VSMY2890RGX01        | Tape and reel | MOQ: 6000 pcs, 6000 pcs/reel | Reverse gullwing |  |
| VSMY2890GX01         | Tape and reel | MOQ: 6000 pcs, 6000 pcs/reel | Gullwing         |  |

Note

MOQ: minimum order quantity

RoHS COMPLIANT

HALOGEN

FREE

**GREEN** 

(5-2008)



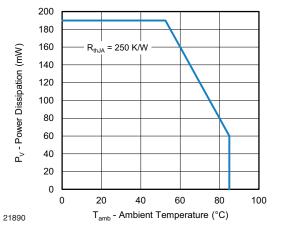


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| <b>ABSOLUTE MAXIMUM RATINGS</b> (T <sub>amb</sub> = 25 °C, unless otherwise specified) |                                  |                   |             |      |
|----------------------------------------------------------------------------------------|----------------------------------|-------------------|-------------|------|
| PARAMETER                                                                              | TEST CONDITION                   | SYMBOL            | VALUE       | UNIT |
| Forward current                                                                        |                                  | IF                | 100         | mA   |
| Peak forward current                                                                   | $t_p/T = 0.5, t_p = 100 \ \mu s$ | I <sub>FM</sub>   | 200         | mA   |
| Surge forward current                                                                  | t <sub>p</sub> = 100 μs          | I <sub>FSM</sub>  | 1           | A    |
| Power dissipation                                                                      |                                  | Pv                | 190         | mW   |
| Junction temperature                                                                   |                                  | Тj                | 100         | °C   |
| Operating temperature range                                                            |                                  | T <sub>amb</sub>  | -40 to +85  | °C   |
| Storage temperature range                                                              |                                  | T <sub>stg</sub>  | -40 to +100 | °C   |
| Soldering temperature                                                                  | According to Fig. 9, J-STD-020   | T <sub>sd</sub>   | 260         | °C   |
| Thermal resistance junction-to-ambient                                                 | JESD51                           | R <sub>thJA</sub> | 250         | K/W  |





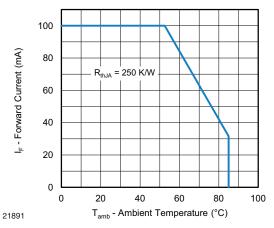


Fig. 2 - Forward Current Limit vs. Ambient Temperature

| <b>BASIC CHARACTERISTICS</b> (T <sub>amb</sub> = 25 °C, unless otherwise specified) |                                                 |                  |                                       |       |      |       |
|-------------------------------------------------------------------------------------|-------------------------------------------------|------------------|---------------------------------------|-------|------|-------|
| PARAMETER                                                                           | TEST CONDITION                                  | SYMBOL           | MIN.                                  | TYP.  | MAX. | UNIT  |
| Forward valtage                                                                     | I <sub>F</sub> = 100 mA, t <sub>p</sub> = 20 ms | V <sub>F</sub>   | -                                     | 1.7   | 1.9  | V     |
| Forward voltage                                                                     | $I_F = 1 \text{ A}, t_p = 100 \ \mu \text{s}$   | V <sub>F</sub>   | -                                     | 2.8   | -    | V     |
| Temperature coefficient of V <sub>F</sub>                                           | I <sub>F</sub> = 100 mA                         | TK <sub>VF</sub> | -                                     | -2.0  | -    | mV/K  |
| Reverse current                                                                     |                                                 | I <sub>R</sub>   | Not designed for reverse operation µ/ |       | μA   |       |
| Junction capacitance                                                                | $V_{R} = 0 V, f = 1 MHz, E = 0 mW/cm^{2}$       | CJ               | -                                     | 60    | -    | pF    |
| Padiant intensity                                                                   | $I_F = 100 \text{ mA}, t_p = 20 \text{ ms}$     | l <sub>e</sub>   | 50                                    | 135   | 175  | mW/sr |
| Radiant intensity                                                                   | $I_F = 1 \text{ A}, t_p = 100 \ \mu \text{s}$   | l <sub>e</sub>   | -                                     | 1000  | -    | mW/sr |
| Radiant power                                                                       | I <sub>F</sub> = 100 mA, t <sub>p</sub> = 20 ms | фе               | -                                     | 55    | -    | mW    |
| Temperature coefficient of radiant power                                            | l <sub>F</sub> = 100 mA                         | TKφe             | -                                     | -0.12 | -    | %/K   |
| Angle of half intensity                                                             |                                                 | φ                | -                                     | ± 10  | -    | ٥     |
| Peak wavelength                                                                     | l <sub>F</sub> = 100 mA                         | λ <sub>p</sub>   | 870                                   | 890   | 910  | nm    |
| Spectral bandwidth                                                                  | I <sub>F</sub> = 100 mA                         | Δλ               | -                                     | 35    | -    | nm    |
| Temperature coefficient of $\lambda_p$                                              | l <sub>F</sub> = 100 mA                         | ΤΚλ <sub>p</sub> | -                                     | 0.3   | -    | nm/K  |
| Rise time                                                                           | I <sub>F</sub> = 100 mA, 10 % to 90 %           | t <sub>r</sub>   | -                                     | 15    | -    | ns    |
| Fall time                                                                           | I <sub>F</sub> = 100 mA, 10 % to 90 %           | t <sub>f</sub>   | -                                     | 15    | -    | ns    |

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## VSMY2890RGX01, VSMY2890GX01

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### BASIC CHARACTERISTICS (T<sub>amb</sub> = 25 °C, unless otherwise specified)

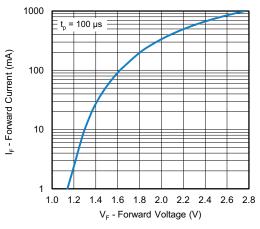


Fig. 3 - Forward Current vs. Forward Voltage

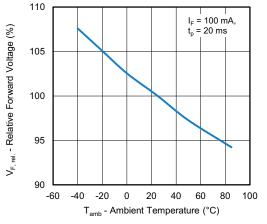


Fig. 4 - Relative Forward Voltage vs. Ambient Temperature

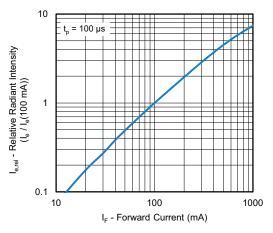


Fig. 5 - Relative Radiant Intensity vs. Forward Current

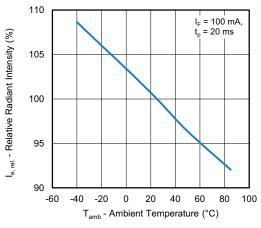


Fig. 6 - Relative Radiant Intensity vs. Ambient Temperature

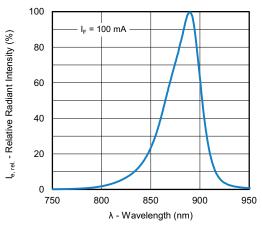
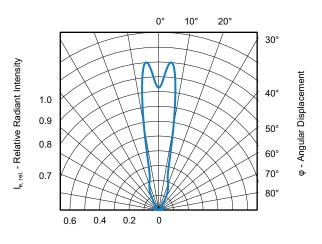


Fig. 7 - Relative Radiant Intensity vs. Wavelength





Rev. 1.0, 17-Jul-2019

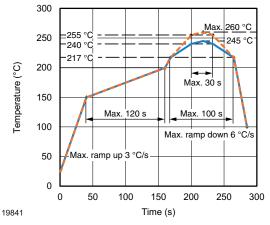
3 For technical questions, contact: <u>emittertechsupport@vis</u> Document Number: 84970

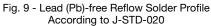
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## VSMY2890RGX01, VSMY2890GX01

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### SOLDER PROFILE





### DRYPACK

Devices are packed in moisture barrier bags (MBB) to prevent the products from moisture absorption during transportation and storage. Each bag contains a desiccant.

### FLOOR LIFE

Floor life (time between soldering and removing from MBB) must not exceed the time indicated on MBB label:

Floor life: 4 weeks

Conditions:  $T_{amb}$  < 30 °C, RH < 60 %

Moisture sensitivity level 2a, according to J-STD-020.

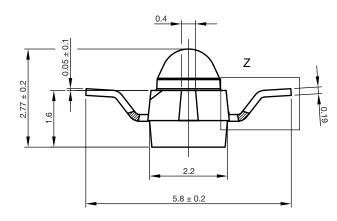
### DRYING

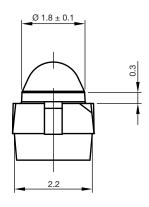
In case of moisture absorption devices should be baked before soldering. Conditions see J-STD-033D or label. Devices taped on reel dry using recommended conditions 192 h at 40 °C (+ 5 °C), RH < 5 %.

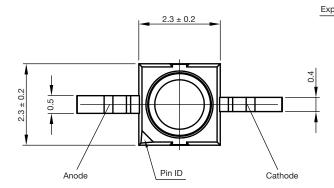


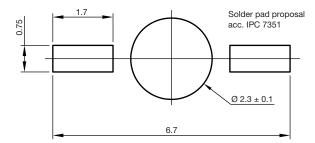
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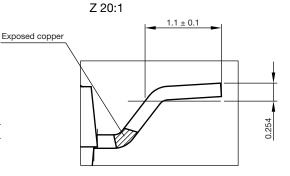
### PACKAGE DIMENSIONS in millimeters: VSMY2890RGX01







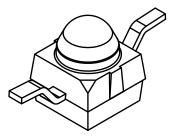






according to DIN specifications

Not indicated tolerances  $\pm 0.1$ 



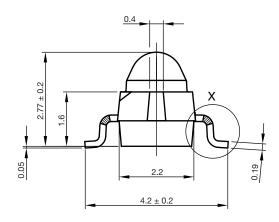
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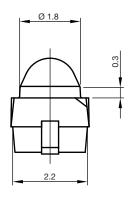
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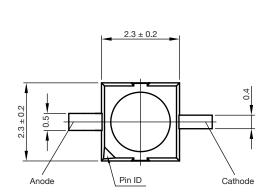


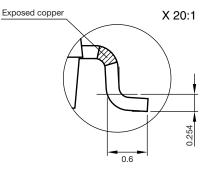
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### PACKAGE DIMENSIONS in millimeters: VSMY2890GX01



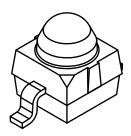


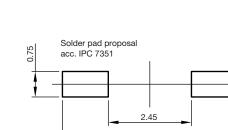






Not indicated tolerances  $\pm 0.1$ 

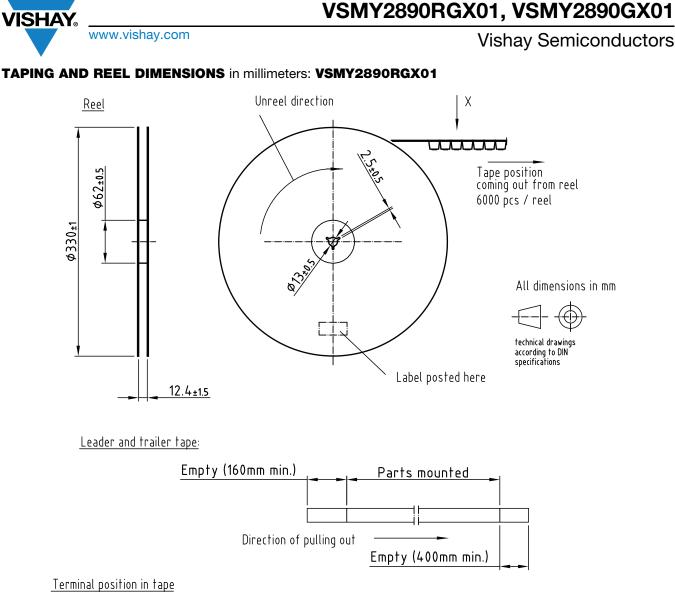




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# Device

| Device         | Lead I           | Lead II |  |
|----------------|------------------|---------|--|
| VEMT 2000      | Collector Emitte |         |  |
| VEMT 2500      | Collector        | Emitter |  |
| VEMD 2000      |                  |         |  |
| VEMD 2500      |                  |         |  |
| VSMB 2000      | Cathode          | Anode   |  |
| VSMG 2000      | Carnoue          | Alloue  |  |
| VSMF 2890 RG   |                  |         |  |
| VSMB 294008 RG |                  |         |  |
| VSMY 2xxx      |                  |         |  |
|                | Anode            | Cathode |  |
| VSMF 288011 RG |                  |         |  |
|                |                  |         |  |

75±0.1 Ø1.55±0.05 4<u>±0.1</u> X 2:1 2±0.05 æ 12±0.3 5.5±0.05 3.05±0.1  $4 \pm 0.1$ Π

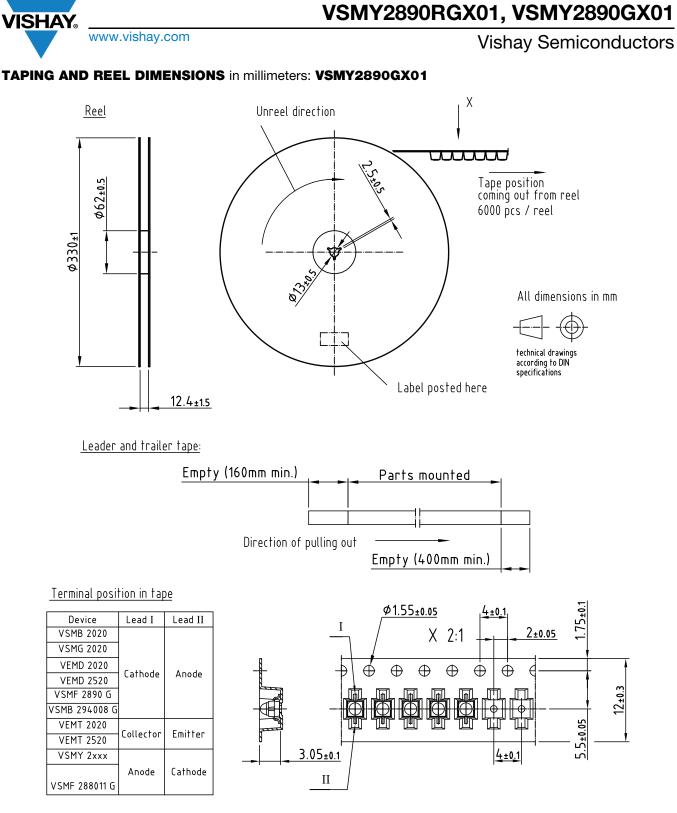
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see table

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